

EVERBRIGHT LIMITED

EVERBRIGHT FLUXED

Model: EV-FR502

Company Name: ______ Confirmed By ______ DATE: _____

Hongkong Everbright Science & echnology Co., Ltd

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■Absolute Maximum Rating			
Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	20	mA
Peak Forward Current*	IFP	160	mA
Reverse Voltage	Vr	5	V
Power Dissipation	PD	60	mW
Electrostatic discharge	Esd	800	V
Operation Temperature	Topr	-25∽+80	°C
Storage Temperature	Tstg	-40∽+80	°C
Lead Soldering Temperature*	Tsol	Max. 260°C for 5sec Max.	

*IFP Conditions: Pulse Width \leq 10msec duty \leq 1/10

*Tsol Conditions: 3mm from the base of the epoxy bulb

■ Typical Optical/ Electrical Characteristics

For specification of emitted color(as shown below), please refer to each Part No on the webpage,

Dominant Wavelength

Forward Voltage

Luminous Intensity

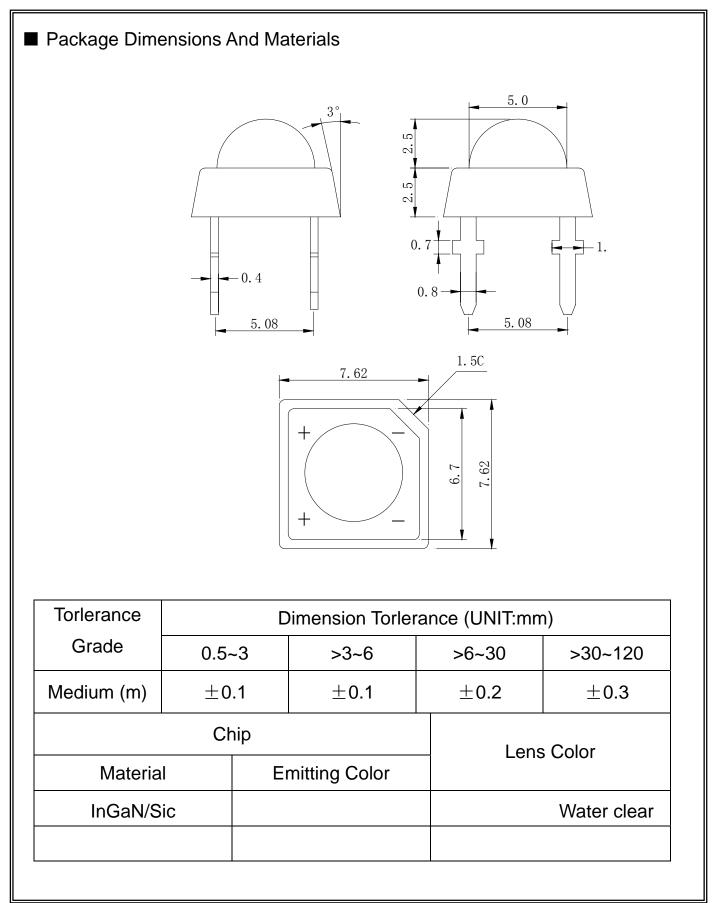
Reverse Current

Viewing Angle

Test condition

Notes:

- 1. Absolute maximum ratings Ta=25 $^\circ\!{\rm C}$.
- 2. Tolerance of measurement of forward voltage \pm 0.1 V.
- 3. Tolerance of measurement of peak Wavelength \pm 2.0 nm.
- 4. Tolerance of measurement of luminous intensity \pm 15%.



Reliability Performance

1.Test Items And Result

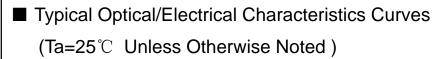
Test Classification	Test Item	Test Conditions	Test Duration	Sample Size	AC/RE	
Life Test	Room Temperature DC Operating Life Test	Ta=25℃±5℃,IF=20mA	1000 hrs	30pcs	0/1	
Environment High Ter Test High H High T S Low Te	Thermal Shock Test	-10°C±5°C >+ 100°C±5°C 5min. 10sec. 5min.	50 cycles	30 pcs	0/1	
	Temperature Cycle Test	-40°C±5°C↔+85°C±5°C 30min. 5min. 30min.	50 cycles	30 pcs	0/1	
	High Temperature & High Humidity Test	Ta=85℃±5℃ RH =85%±0.5 %RH	1000 hrs	30 pcs	0/1	
	High Temperature Storage	Ta=100℃±5℃	1000 hrs	30 pcs	0/1	
	Low Temperature Storage	Ta=-55 ℃±5℃	1000 hrs	30 pcs	0/1	
Mechanical Test	Resistance to Soldering Heat	Ta=230℃±5℃	5sec.	30 pcs	0/1	
	Lead Integrity	Load 2.5N(0.25kgf) 0° ~ 90° ~0°	3times	30 pcs	0/1	

2. Criteria for Judging The Damage

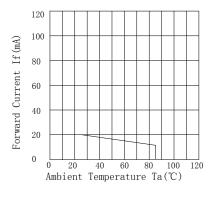
Item	Symbol	Test Conditions	Criteria for Judgment		
			Min.	Max.	
Forward Voltage	Vf	IF=20mA		U.S.L.*1.2	
Reverse Current	lr	VR=5V		U.S.L.*2.2	
Luminous Intensity	Iv	IF=20mA	L.S.L**×0.7		

U.S.L.* : Upper Standard Level

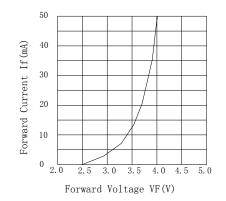
L.S.L.**: Lower Standard Level



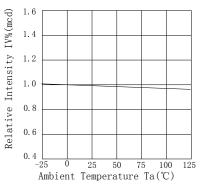
Forward Current vs. Ambient Temperature



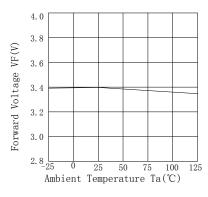
Forward Current vs.Forward Voltage



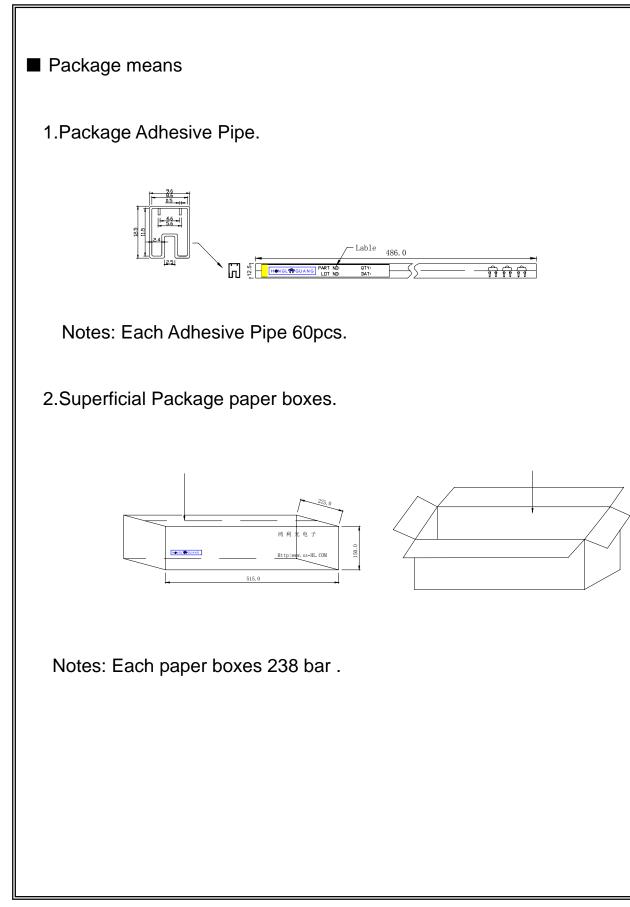
Relative Intensity vs. Ambient Temperature



Forward Voltage vs. Ambient Temperature

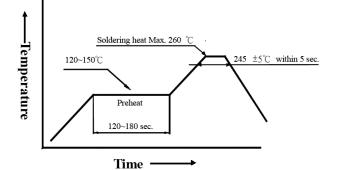


Luminous Spertrum (Ta=25°C) SPECTRAL RADIANCE 100 80 60 60 10



Soldering:

- Manual Of Soldering The temperature of the iron tip should not be higher than 260℃(500°F) and Soldering within 3 seconds per solder-land is to be observed.
- DIP soldering (Wave Soldering): Preheating:120℃~150℃, within 120~180 sec. Operation heating:245℃±5℃ within 5 sec.260℃(Max) Gradual Cooling (Avoid quenching).



Handling:

Care must be taken not to cause to the epoxy resin portion of LED while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of LED with hard or sharp article such as the sand blast and the metal hook.

Care must be taken there should be more than 3mm from jointing point to the epoxy resin.

Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LED within the rated figures .Also caution should be taken not to overload LED with exorbitant voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also the circuit should be designed so as be subjected to reverse voltage when turning off the LED.

Storage:

In order to avoid the absorption of moisture . it is recommended to solder LED as soon as possible after unpacking the sealed envelope.

If the envelope is still packed to store it in the environment as following: Temperature: $5^{\circ}C \sim 30^{\circ}C (41^{\circ}F \sim 86^{\circ}F)$ Humidity : RH 60% Max.

LED and against static:

